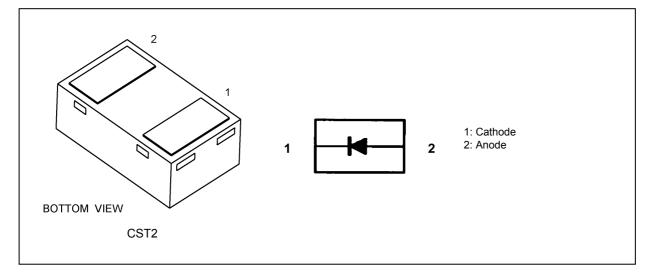
ESD Protection Diodes Silicon Epitaxial Planar

DF2S24UCT

1. Applications

- ESD Protection
- Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$)

| Characteristics | Symbol | Rating | Unit |
|---|------------------|------------|------|
| Electrostatic discharge voltage (IEC61000-4-2)(Contact) | V _{ESD} | ±8 | kV |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | T _{stg} | -55 to 150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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4. Electrical Characteristics (Unless otherwise specified, T_a = 25°C)

| V _{RWM} : Working peak reverse voltage |
|---|
| V _{BR} : Reverse breakdown voltage |
| I _{BR} : Reverse breakdown current |
| V _R : Reverse voltage |
| I _R : Reverse current |
| V _F : Forward voltage |
| I _F : Forward current |
| V _C : Clamping voltage |
| IPP: Peak pulse current |
| R _{DYN} : Dynamic resistance |
| |

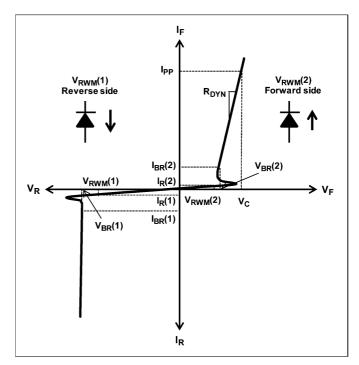


Fig. 4.1 Definitions of Electrical Characteristics

| Characteristics | Symbol | Note | Test Condition | Min | Тур. | Max | Unit |
|------------------------------|----------------------|----------|---------------------------------|-----|------|-----|------|
| Working peak reverse voltage | V _{RWM} (1) | | — | | _ | 19 | V |
| Reverse breakdown voltage | V _{BR} (1) | | I _{BR} = 1 mA | 22 | 24 | _ | V |
| Reverse current | I _R (1) | | V _{RWM} = 19 V | | | 0.5 | μA |
| Dynamic resistance | R _{DYN} | (Note 1) | | _ | 0.5 | _ | Ω |
| Total capacitance | Ct | | V _R = 0 V, f = 1 MHz | _ | 1.6 | _ | pF |
| Working peak reverse voltage | V _{RWM} (2) | | — | | | 5 | V |
| Reverse breakdown voltage | V _{BR} (2) | | I _{BR} = 1 mA | 5.3 | 6.8 | | V |
| Reverse current | I _R (2) | | V _{RWM} = 5 V | _ | _ | 0.1 | μA |

Note 1: TLP parameter: Z0 = 50 Ω , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at I_{PP} between 3 A to 8 A.

5. Guaranteed ESD Protection (Note)

| Test Condition | ESD Protection |
|----------------------------------|----------------|
| IEC61000-4-2 (Contact discharge) | ±8 kV |

Note: Criterion: No damage to devices.

6. Marking

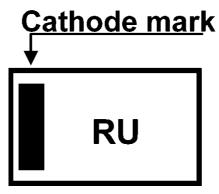


Fig. 6.1 Marking

| Marking Code | Part Number |
|--------------|-------------|
| RU | DF2S24UCT |

7. Land Pattern Dimensions (for reference only)

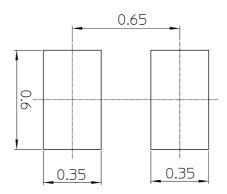
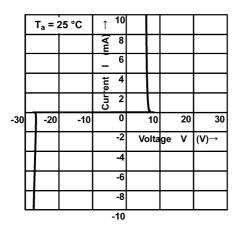


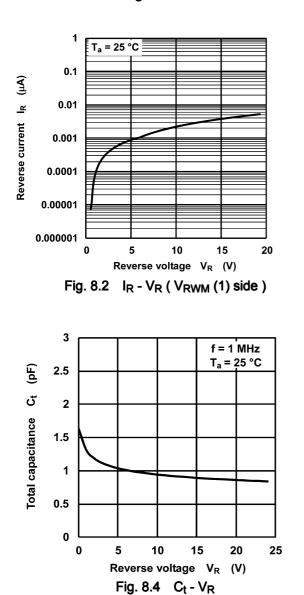
Fig. 7.1 Land Pattern Dimensions (Unit: mm)

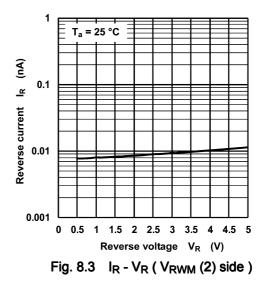
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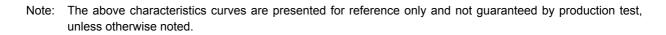
8. Characteristics Curves (Note)



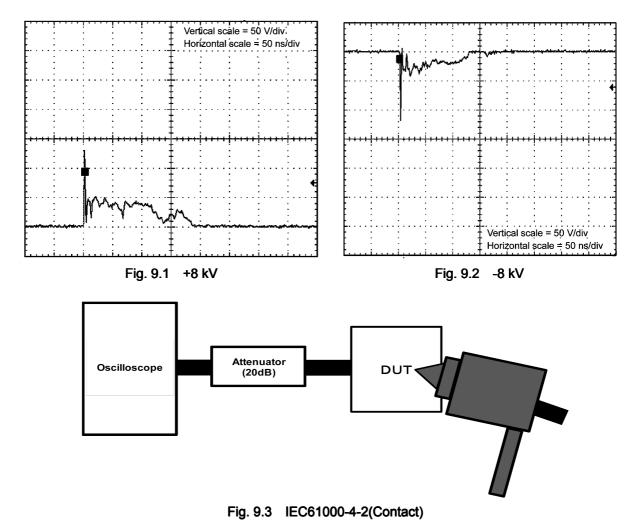








9. ESD Clamp Waveform (Note)



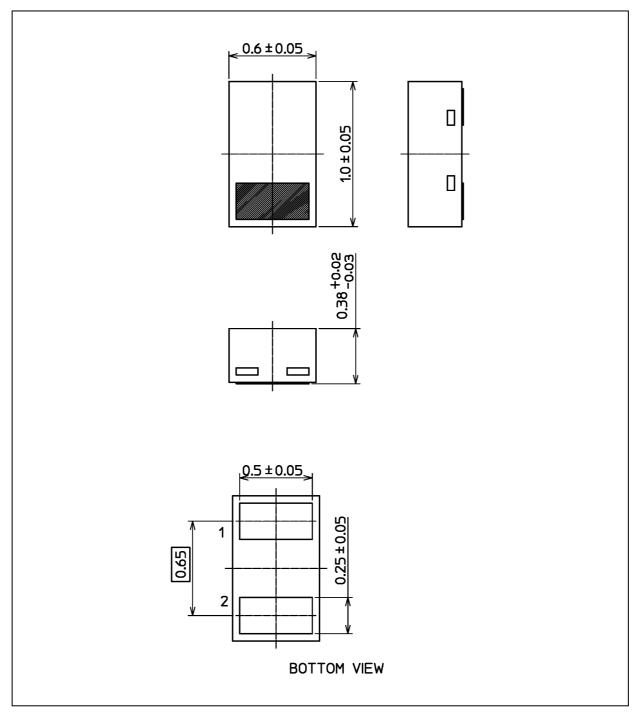
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

DF2S24UCT

Unit: mm



Weight: 0.7 mg (typ.)

| | Package Name(s) |
|-----------------|-----------------|
| TOSHIBA: 1-1P1S | |
| Nickname: CST2 | |

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